

Superconductivity in fractal geometries

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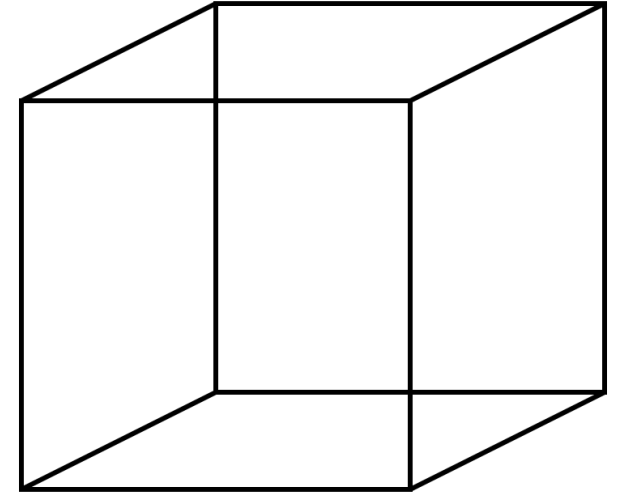
Principal supervisor
Daily supervisor
2nd corrector

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: dr. R. Fermin
: dr. W. Löffler

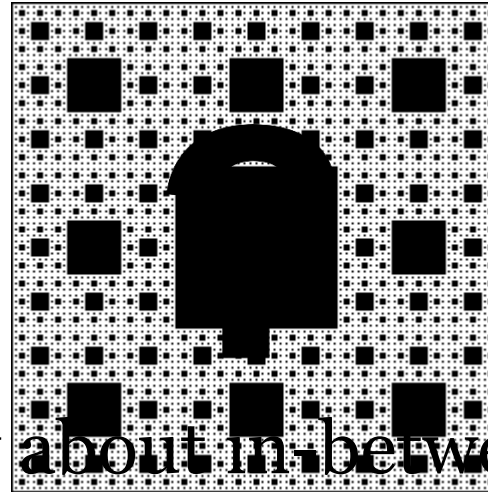
Going between dimensions



2D



3D



How about in-between?

$\ln(8) / \ln(3)$ (≈ 1.89)
dimensional?

Fractals:
e.g. Sierpiński carpet
(left)

From: Wikipedia (CC)

Characterization of dimensionality

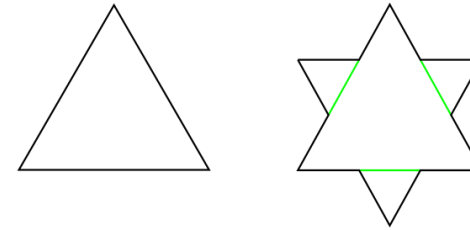
- Hausdorff dimension:

Generalisation of dimension from real vector spaces to arbitrary metric spaces

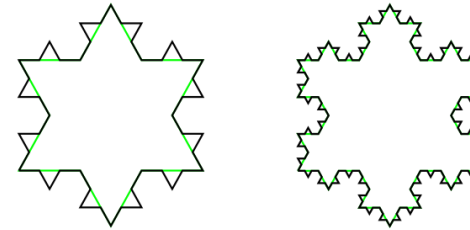
Hausdorff dimension d reduces to usual dimension for non-fractal geometries (e.g. $d_{\text{point}} = 0$, $d_{\text{line}} = 1$ etc.)

- Fractals:

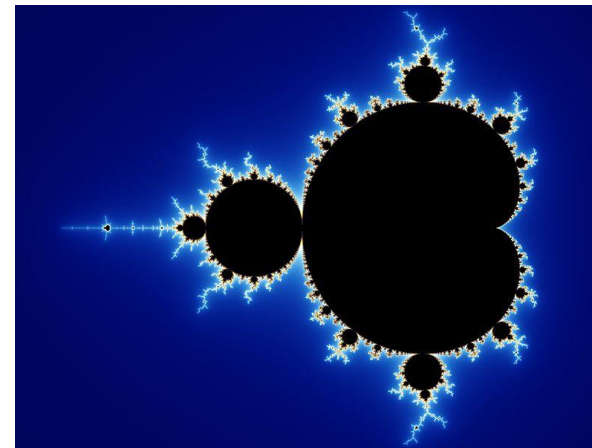
No consensus on definition ('never-ending pattern')



Koch snowflake,
Hausdorff dim.
 $2\ln(2) / \ln(3) \approx 1.26$



Wikipedia (CC)



Mandelbrot set,
Hausdorff dim. 2

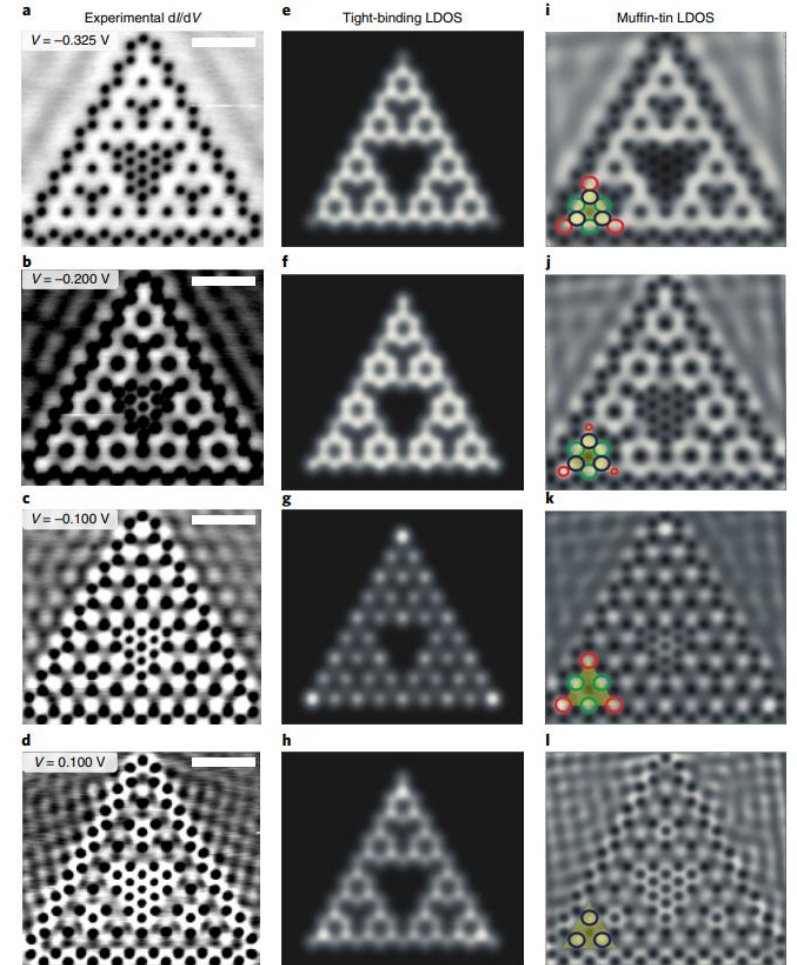
Wikipedia (CC)

Motivation

- STM paper: advances in the exploration of fractal geometries in electronic quantum systems

Design and characterization of electrons in a fractal geometry

S. N. Kempkes^{1,3}, M. R. Slot^{2,3}, S. E. Freeney², S. J. M. Zevenhuizen², D. Vanmaekelbergh², I. Swart^{2*} and C. Morais Smith^{1*}



Link with superconductivity

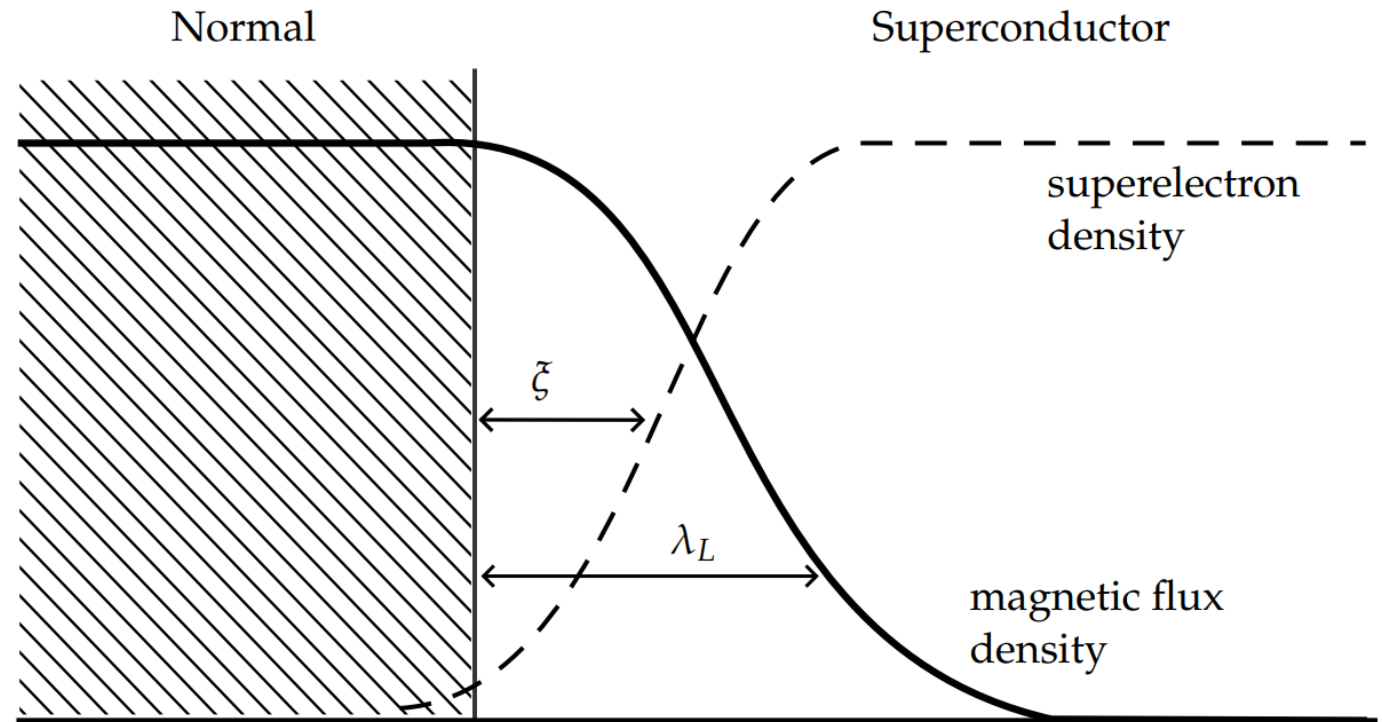
Brief intro superconductivity

- Condensate: (bosonic) cooper pairs
- Ginzburg-Landau equations

2nd G-L equation:

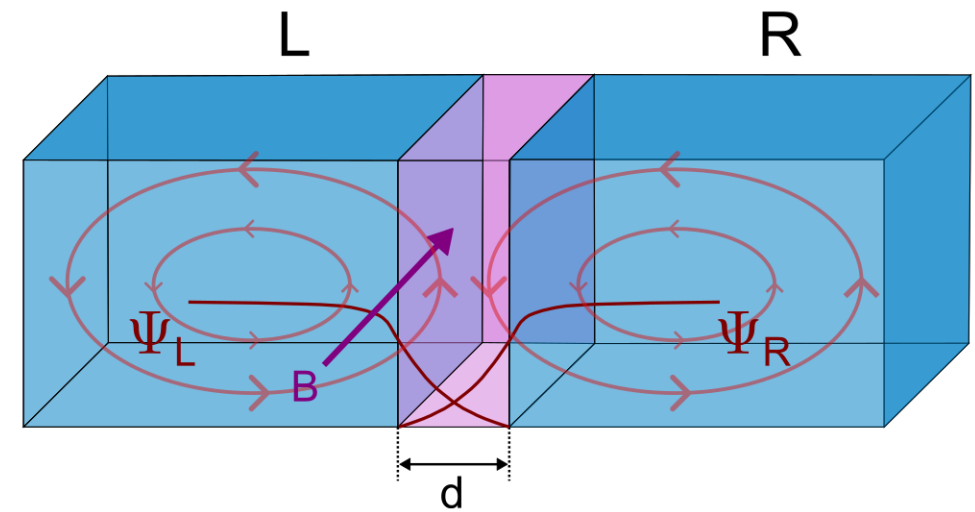
$$\mathbf{J} = -\frac{\Phi_0}{2\pi\mu_0\lambda^2} \left(\frac{2\pi}{\Phi_0} \mathbf{A} + \nabla\gamma \right)$$

- Characteristic length scales:
 ξ and λ
- Meissner effect

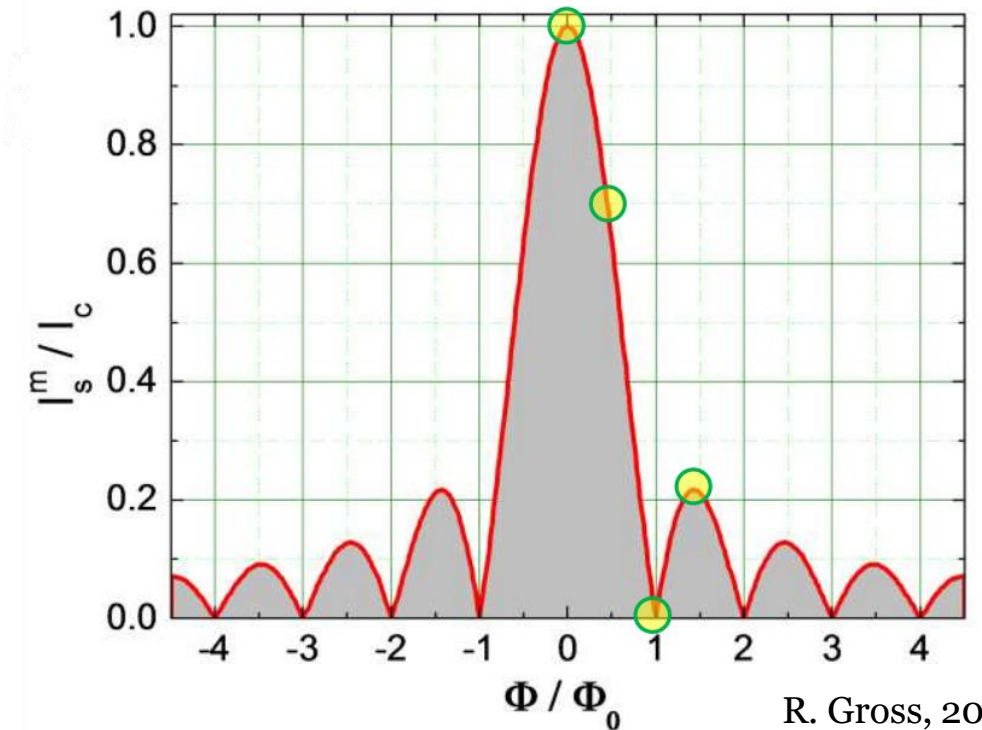


Josephson junctions, 3D

- Superconductors separated by weak-link
- Overlap between wave functions
- Interference:
 - Fraunhofer pattern when plotting applied magnetic field vs critical current.
 - Periodicity determined by effective junction length $2\lambda + d$.



Fermin, phd thesis, 2022



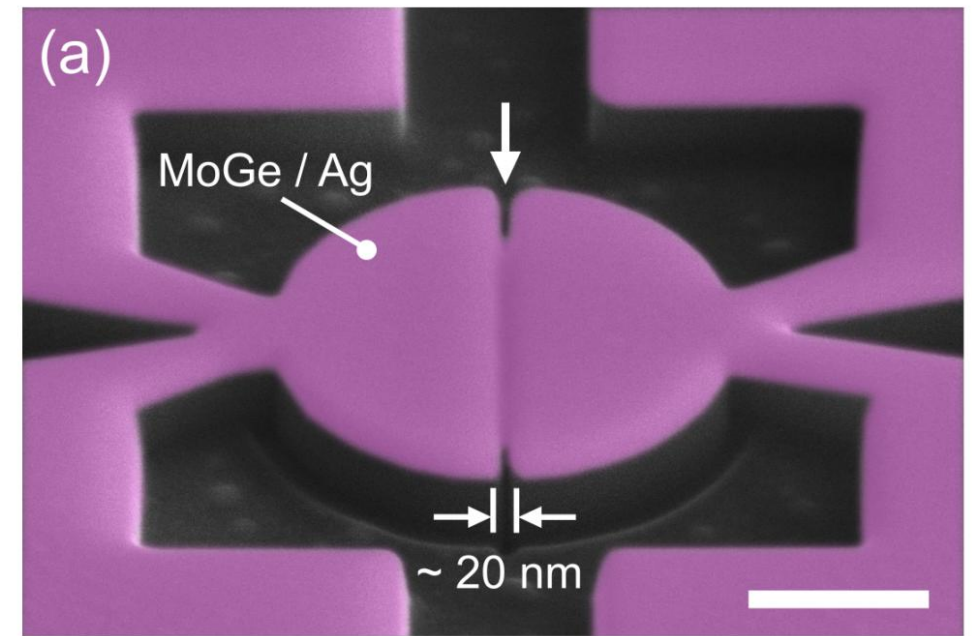
R. Gross, 2020

2D: thin film planar Josephson junctions

- Critical current solely determined by geometry (not λ)
- Thin film planar junctions + restricted in lateral size:
in the asymptotic limits critical current solely determined by area (not even geometry anymore!)
- Why 2D: we can simulate

TOP: Schematic of thin film elliptical laterally constrained Josephson junction

BOTTOM: Side view



Theory: background

- Finding γ also from 2nd Ginzburg-Landau equation, assuming:

supercurrent conservation (1)

Coulomb gauge (2)

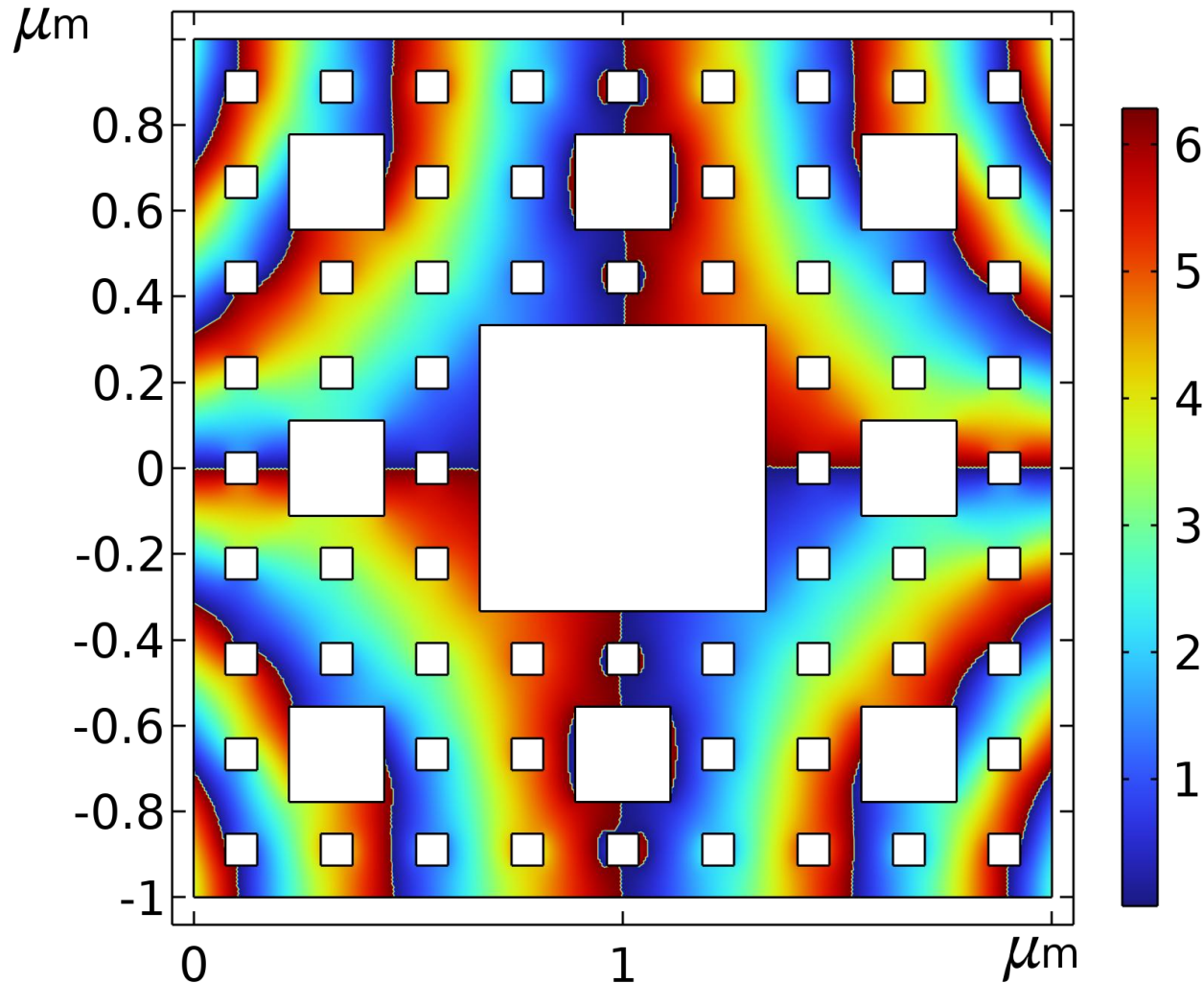
$$\nabla \cdot \mathbf{J} = 0 \quad \nabla \cdot \mathbf{A} = 0$$

- G-L mapped onto Laplace equation:

$$\mathbf{J} = -\frac{\Phi_0}{2\pi\mu_0\lambda^2} \left(\frac{2\pi}{\Phi_0} \mathbf{A} + \nabla\gamma \right) \quad \longrightarrow \quad \boxed{\nabla^2\gamma = 0}$$

we can solve this (with appropriate B.C.'s)

Fractal Josephson junctions

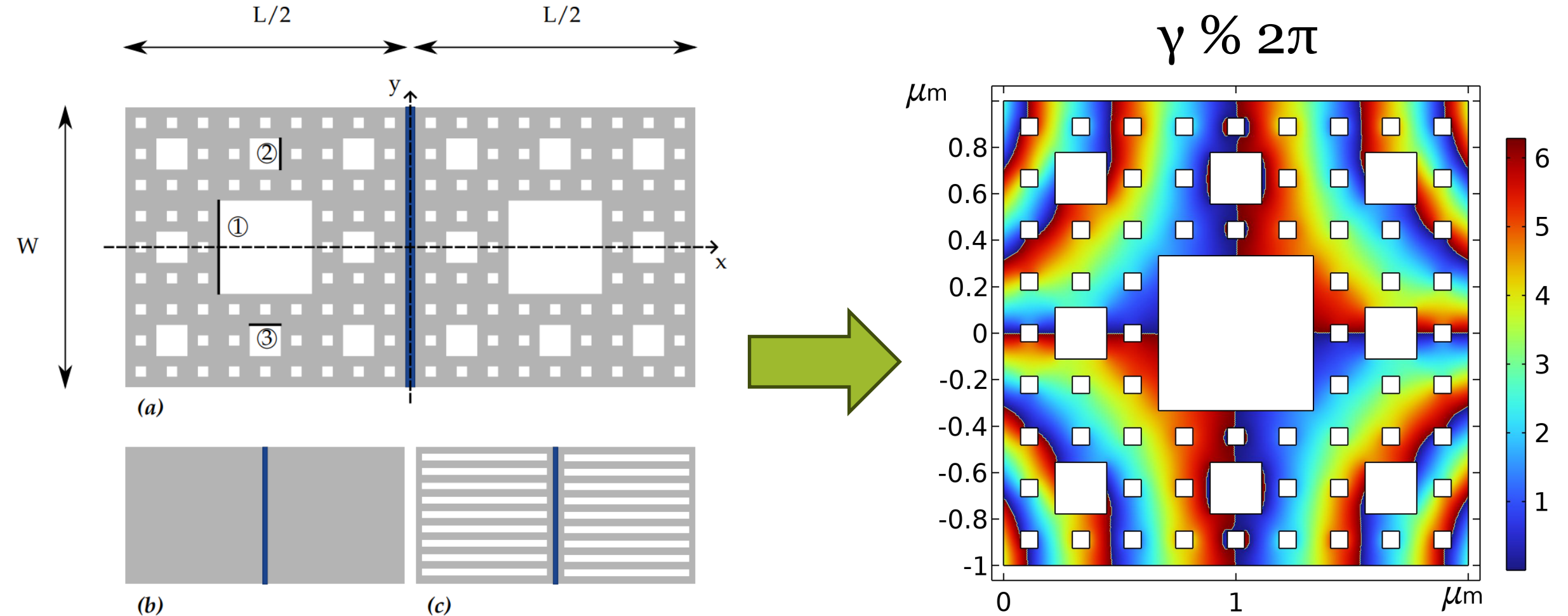


- Fractals in COMSOL
Sierpinski carpet: Hausdorff dim. 1.89

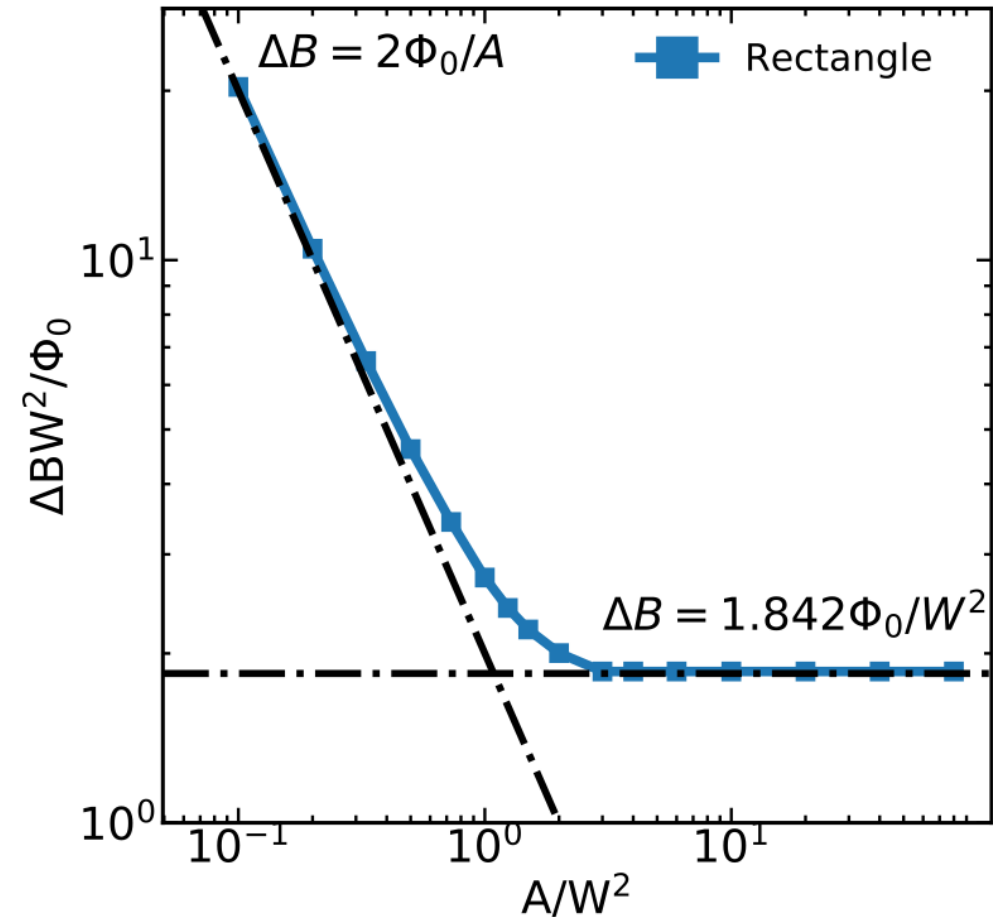
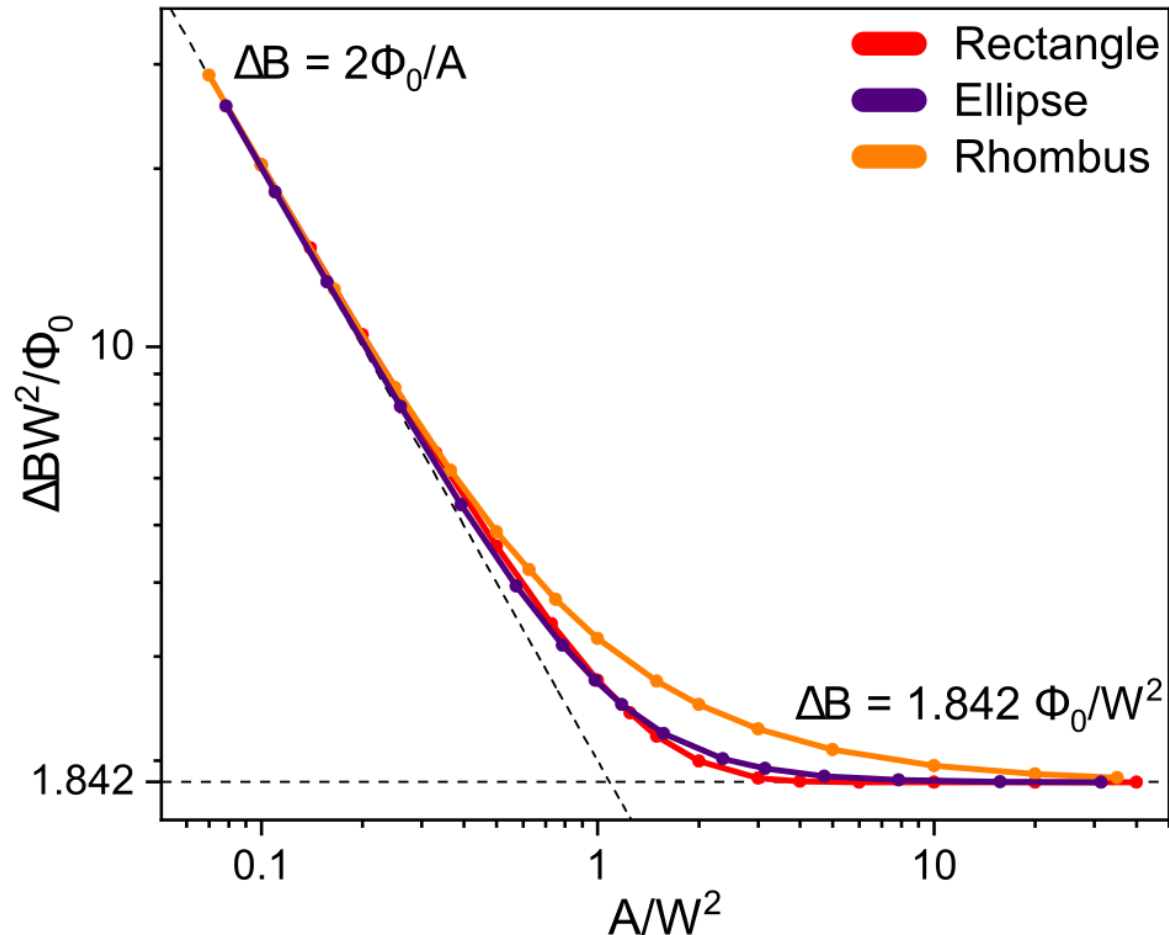
- Probing the limits
Looking for asymptotic behaviour

Distribution of $\gamma \mod 2\pi$ on the surface
of a 3rd iteration Sierpiński carpet in
COMSOL

Simulations: phase distribution



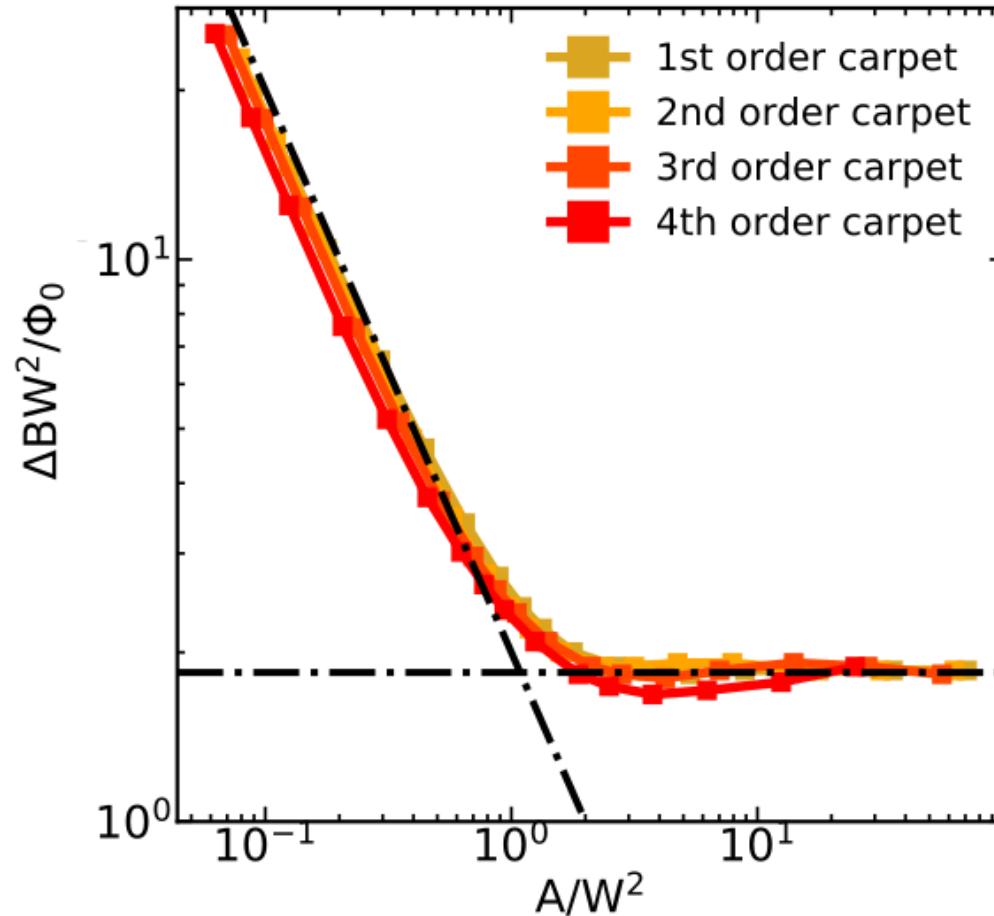
Simulations: periodicity (I)



LEFT: dependence of periodicity on sample area for various geometries of the electrodes (Fermin, 2023)

RIGHT: independent confirmation of same behaviour for rectangular electrodes

Simulations: periodicity (II)



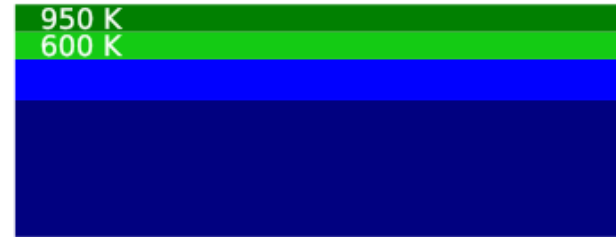
LEFT: dependence of periodicity on sample area for various iterations of the Sierpinski carpet

RIGHT: dependence of periodicity on sample with non-fractal geometry, but identical surface-to-hole area

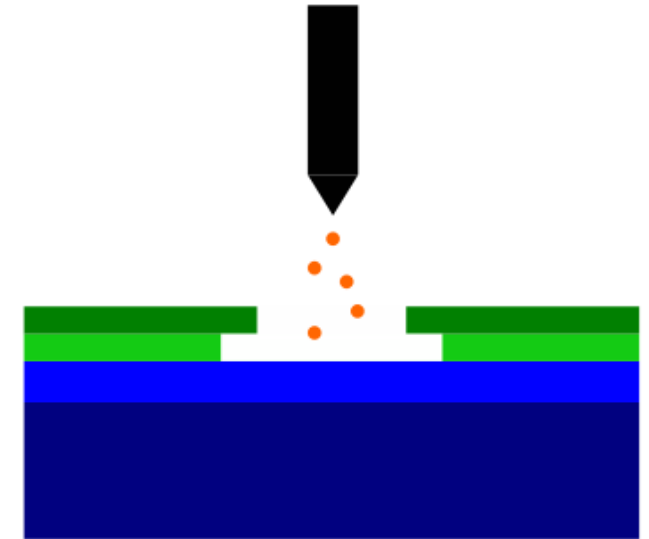
Nanofabrication



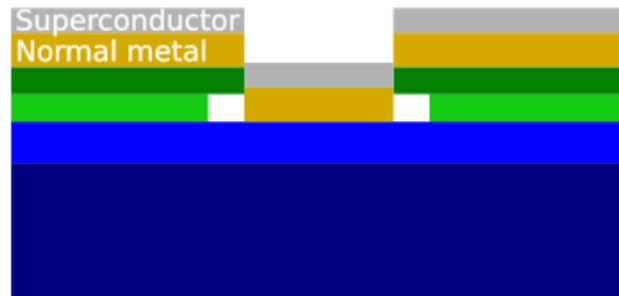
Empty substrate



Spin-coating



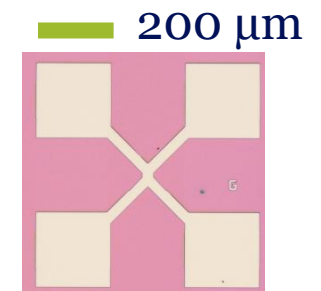
E-beam lithography



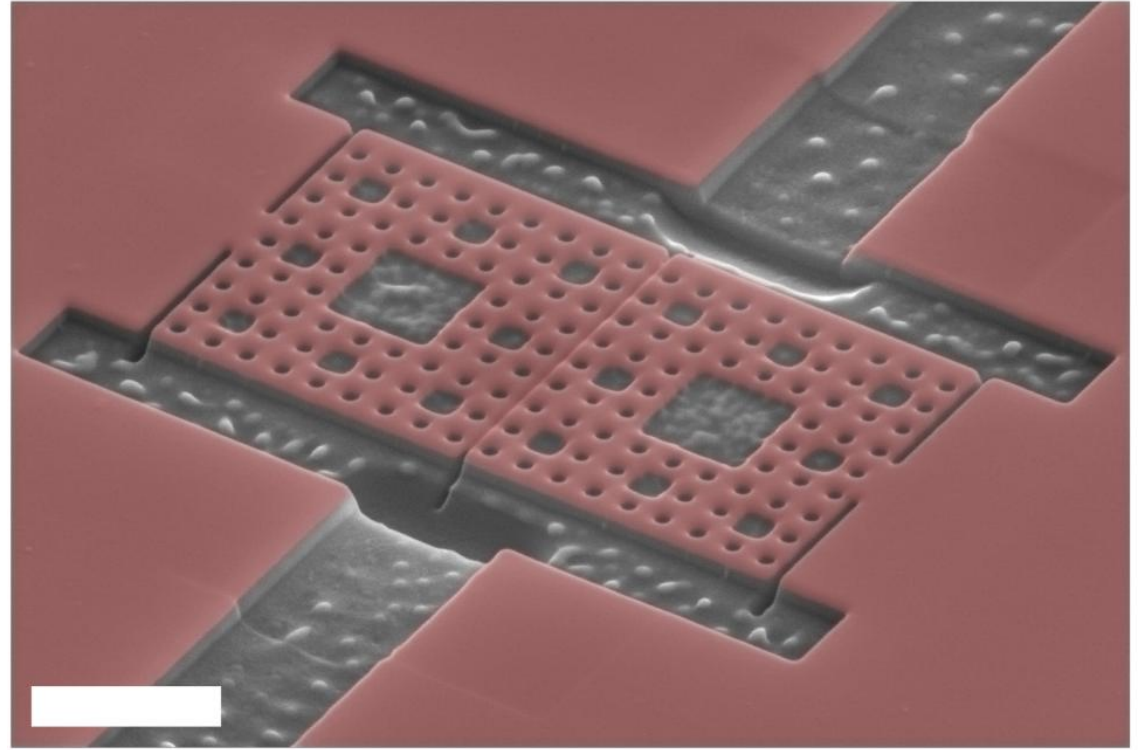
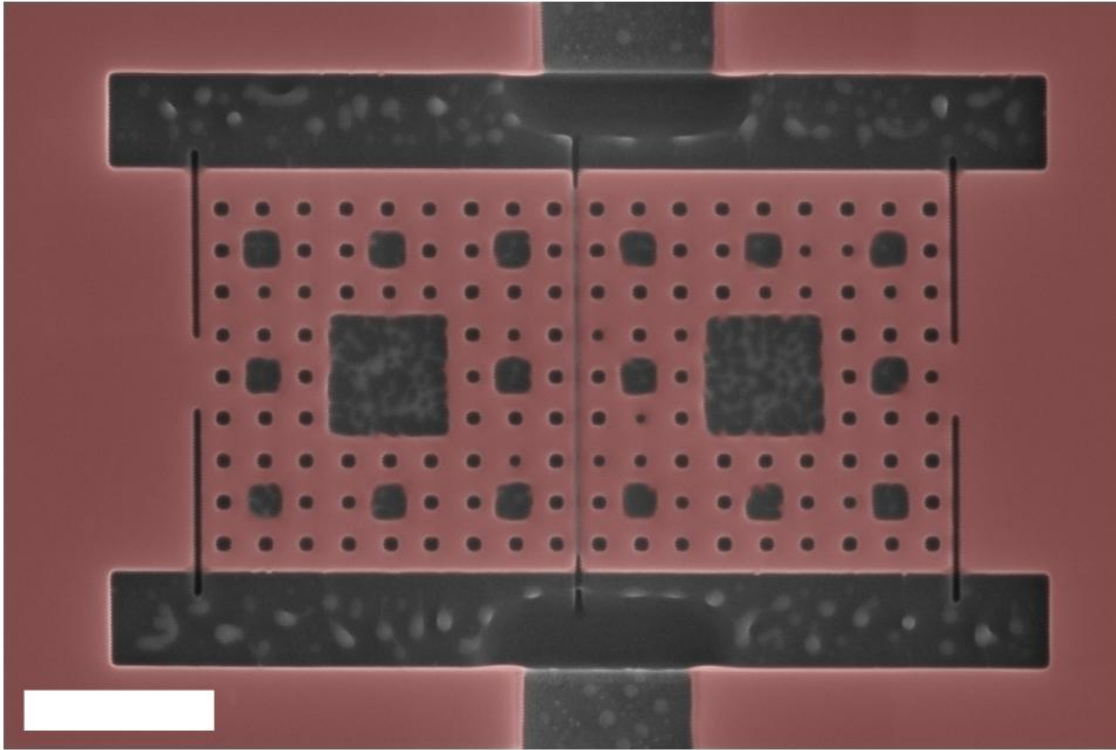
Sputtering



Lift-off



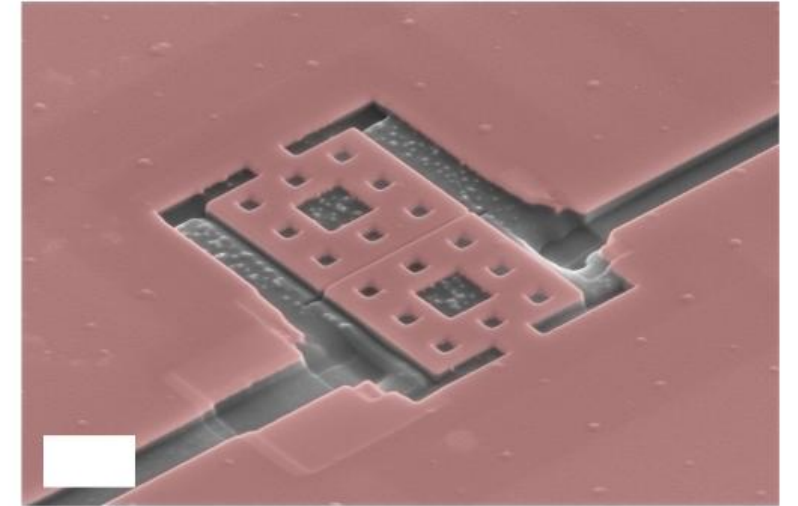
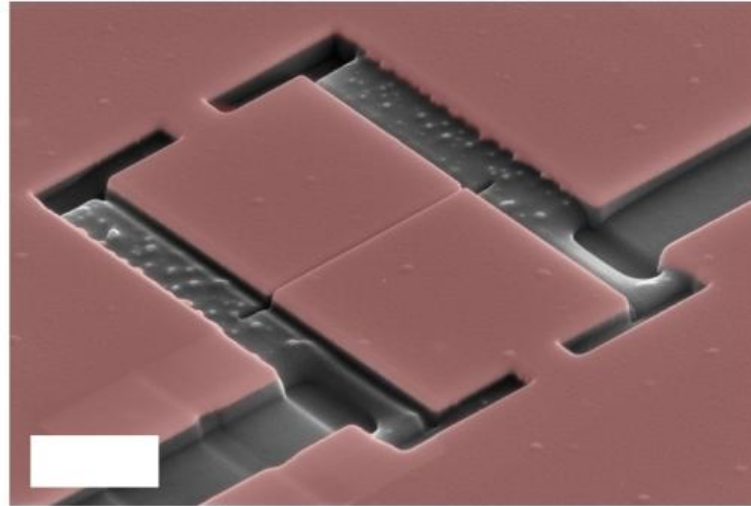
FIB results (I)



Third order Sierpiński carpet electrodes:

- Non-uniform holes...
- Damage to weak link...

FIB results (II)

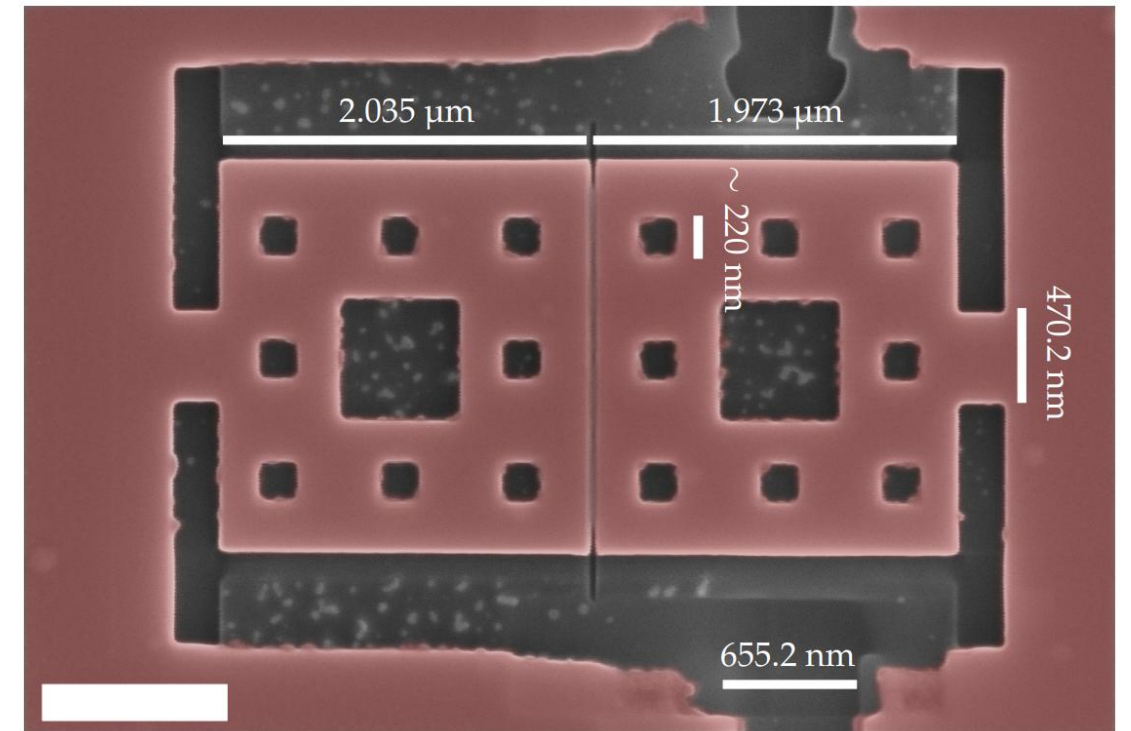


Second order Sierpiński carpet electrodes:

- Uniform holes
- No damage to weak link

Rectangular electrodes:

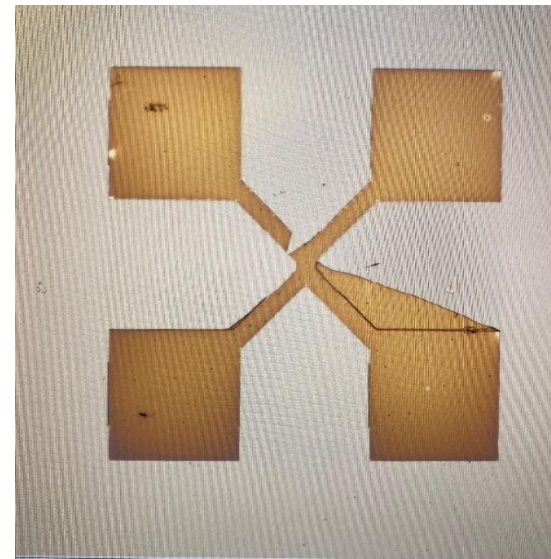
- Compare results with literature



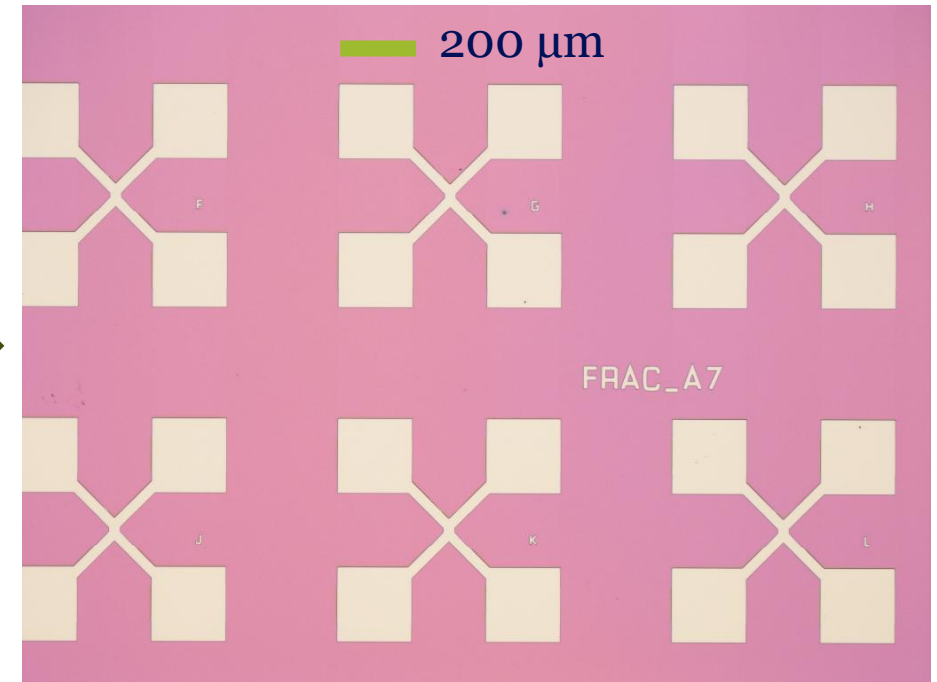
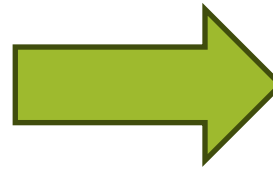
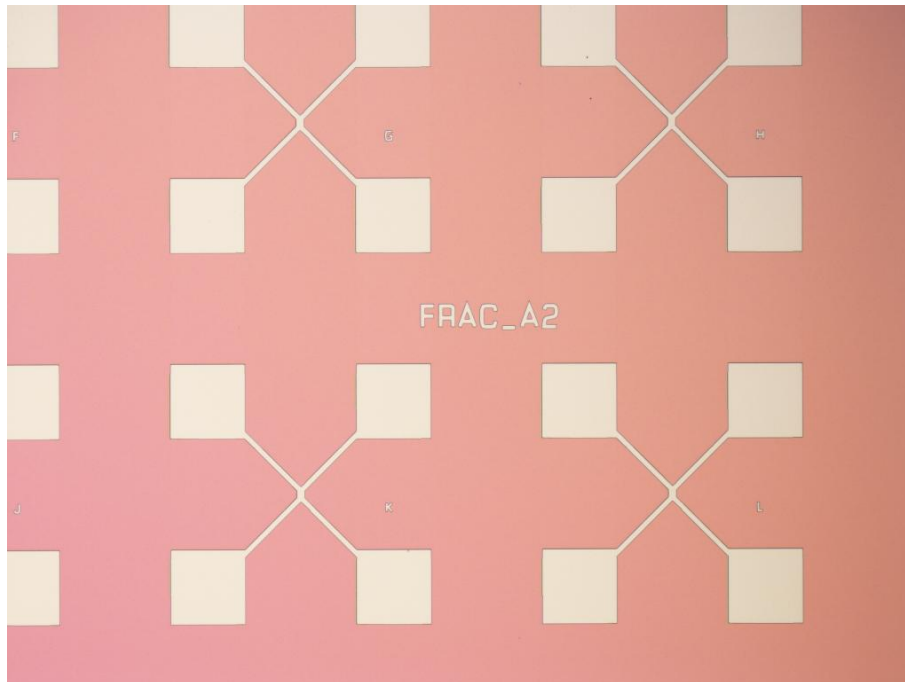
Challenges (I)

Weak attachment:

- Thicker elements



LEFT: unsuccessful lift-off



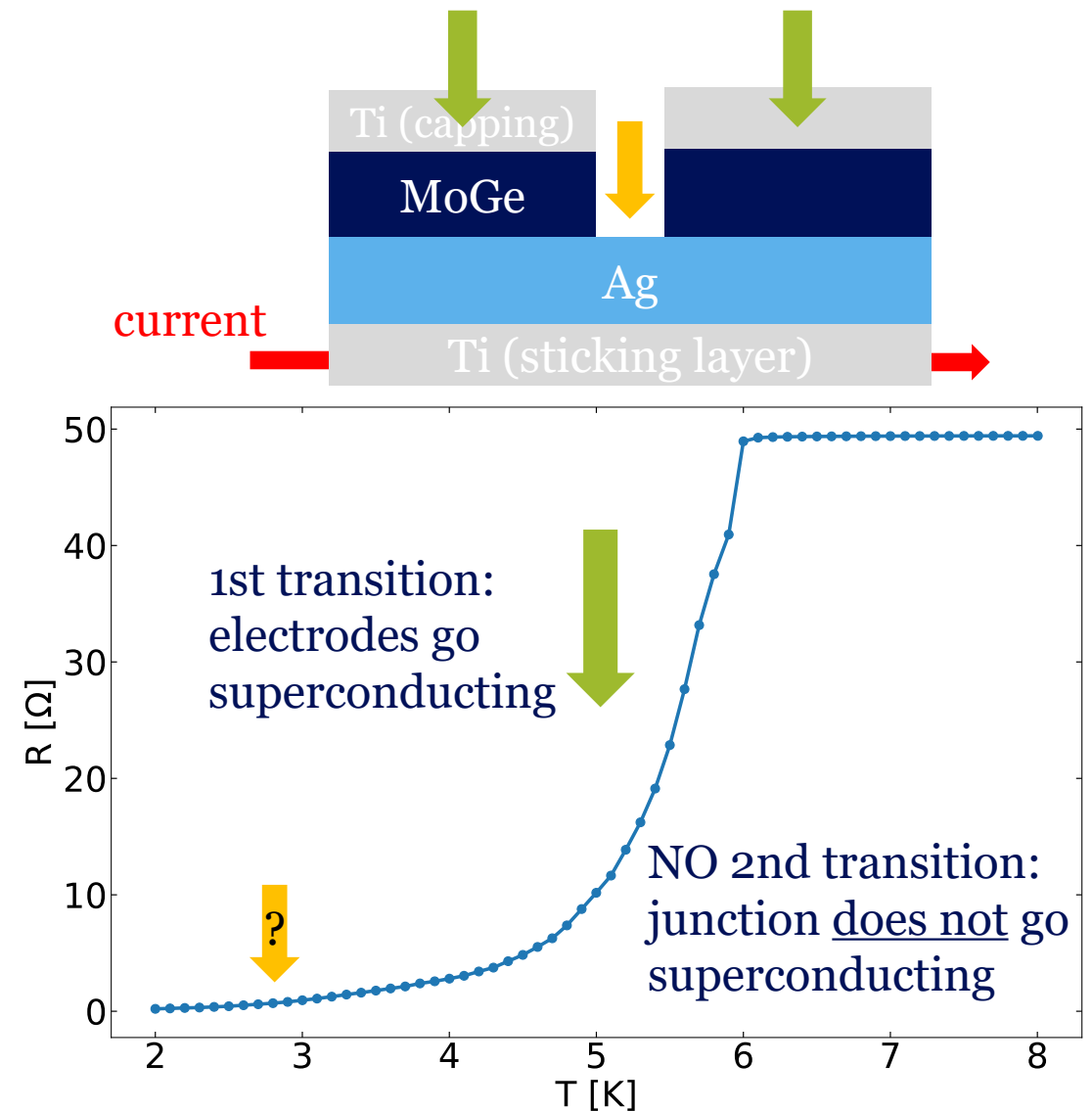
Challenges (II)

Solve weak attachment:

- Sticking layer: 4 nm MoGe
- MoGe superconducting > shorts the junction
- Switch to 5 nm Ti

Prevent FIB damage:

- 5 nm Ti capping layer against FIB-damage



MoGe sticking layer shorts the junction: no second transition

Resistance vs temperature

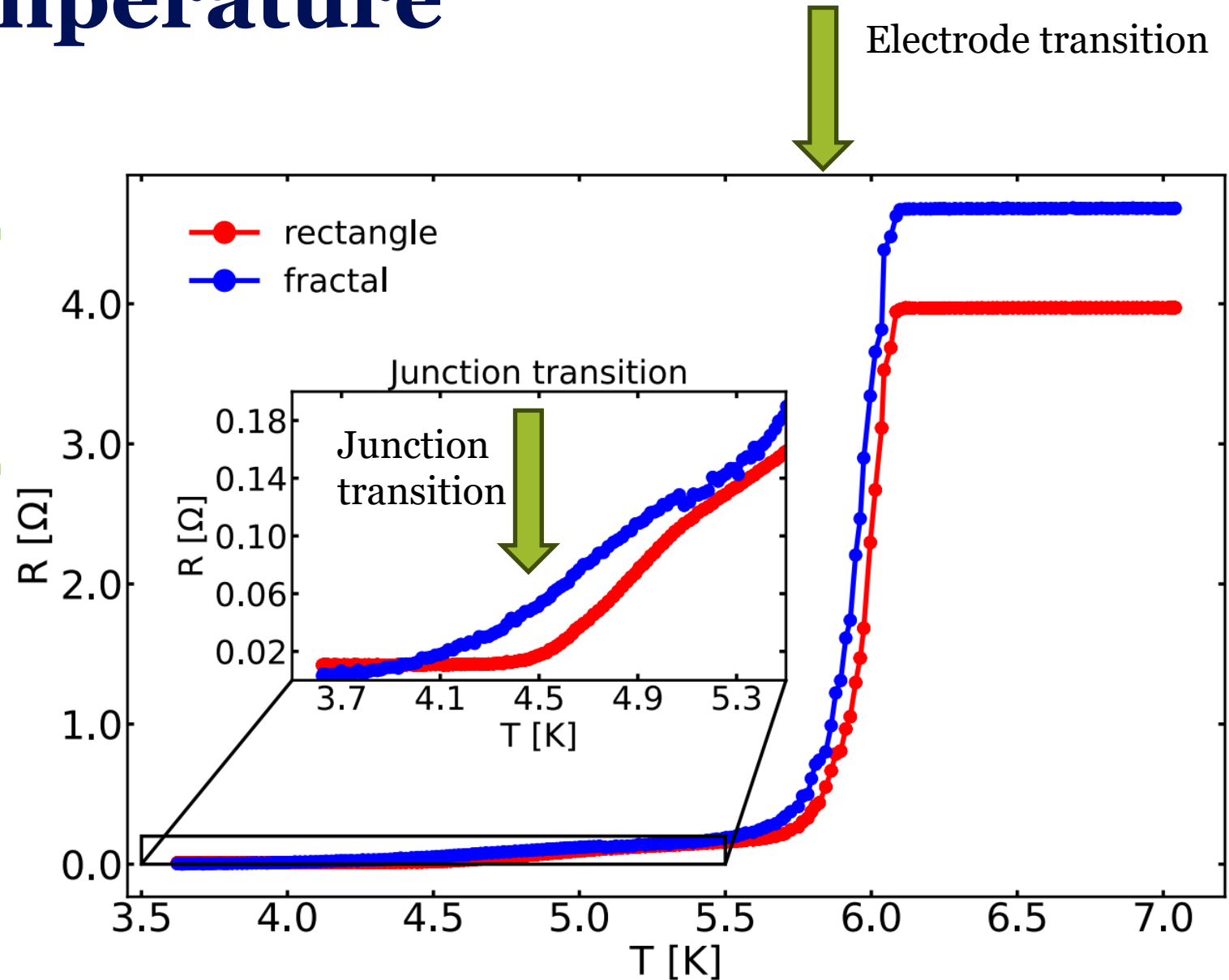
- Two transitions:

- ☐ electrodes

- ☐ junction

- Fractal: higher normal state resistance

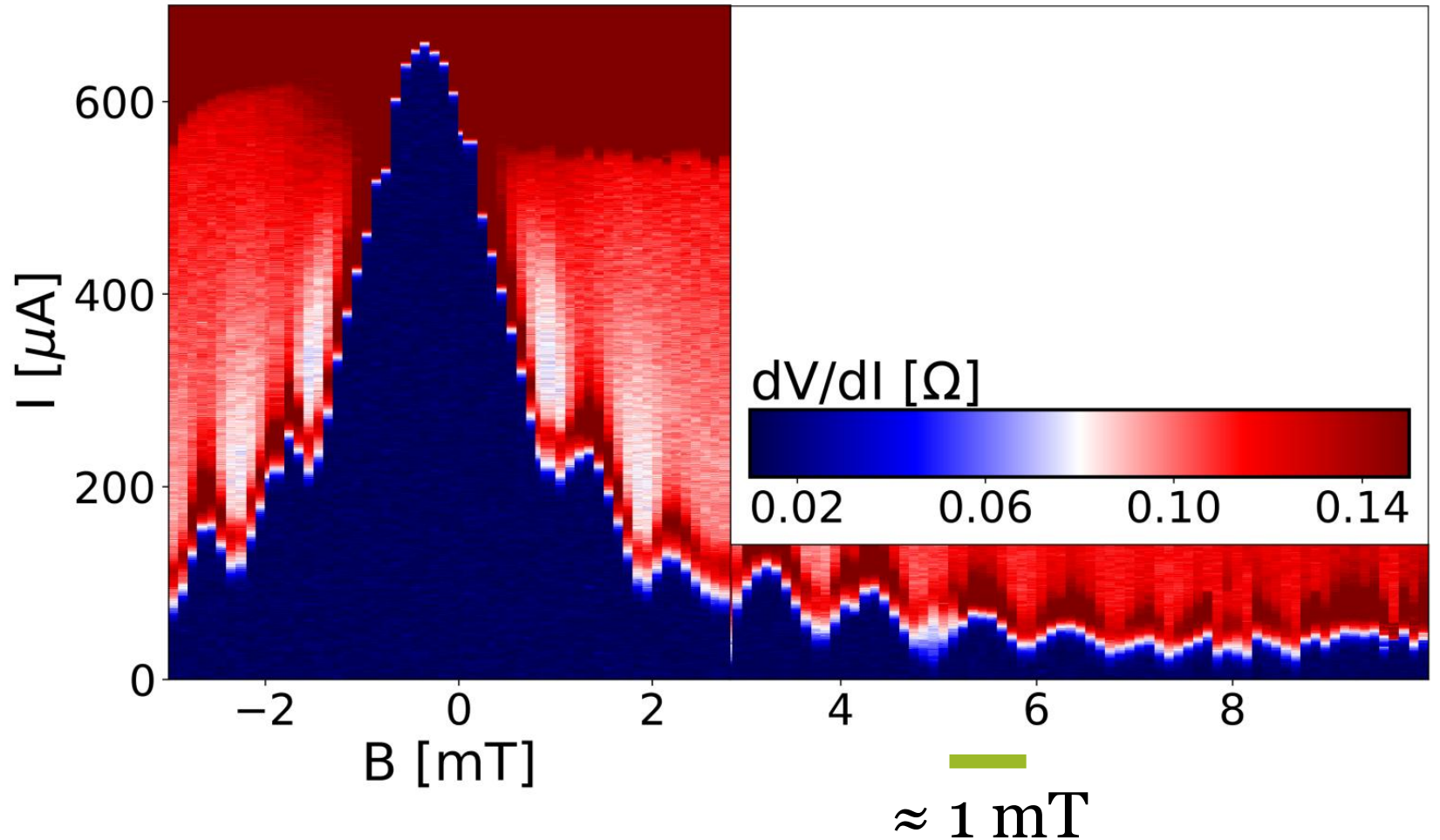
- Fractal: slightly lower T_c



SQI-patterns: Rectangular junction

- Periodicity agrees with simulations
- Long junction limit

$$W > \frac{\Phi_0}{4\pi\mu_0\lambda^2 J_c(0)}$$

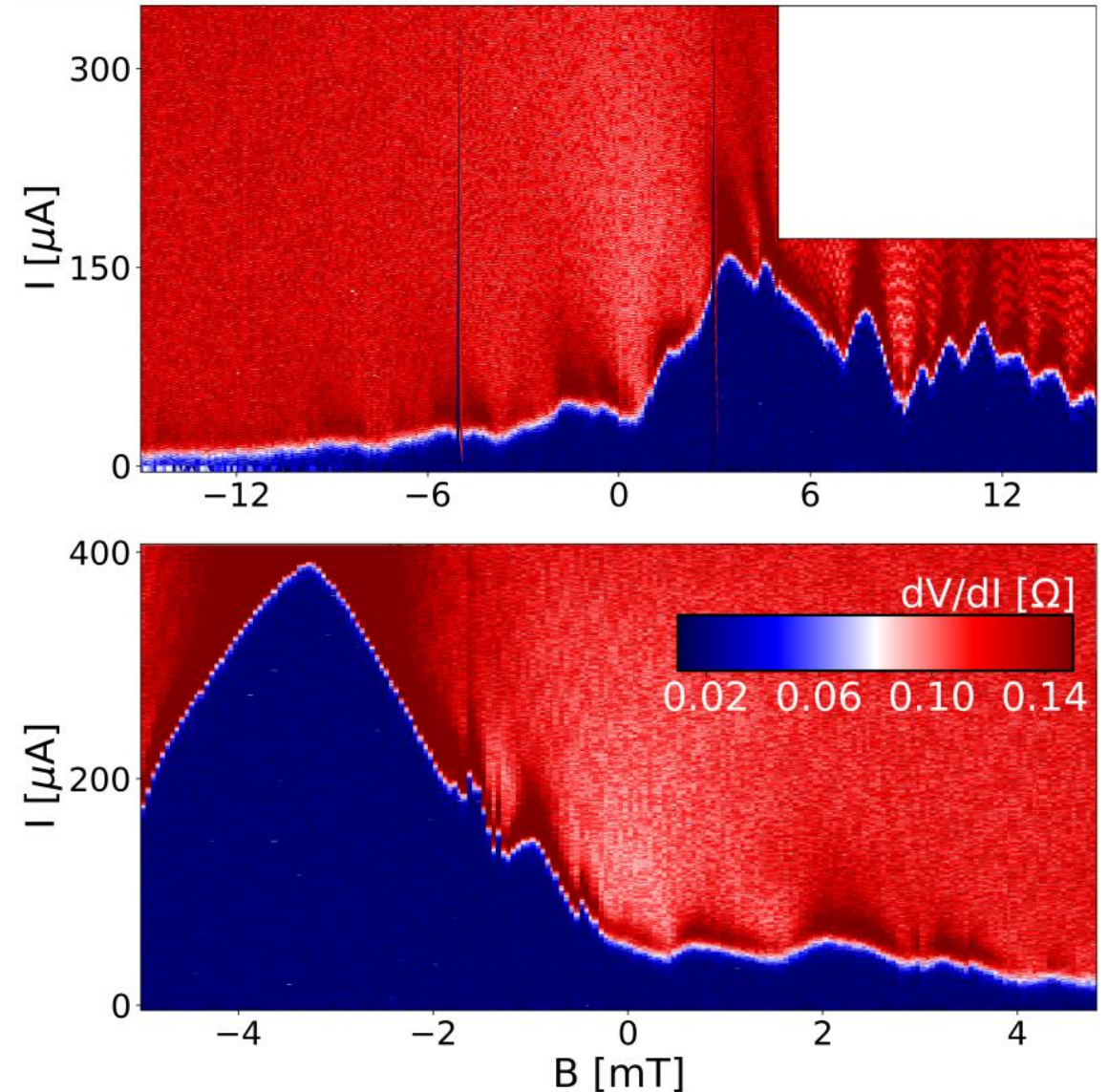


SQI-patterns: Fractal junction

- Maximum not @ zero T
- Visible oscillations have irregular periodicity
- Pattern irreproducible

Conclusion:

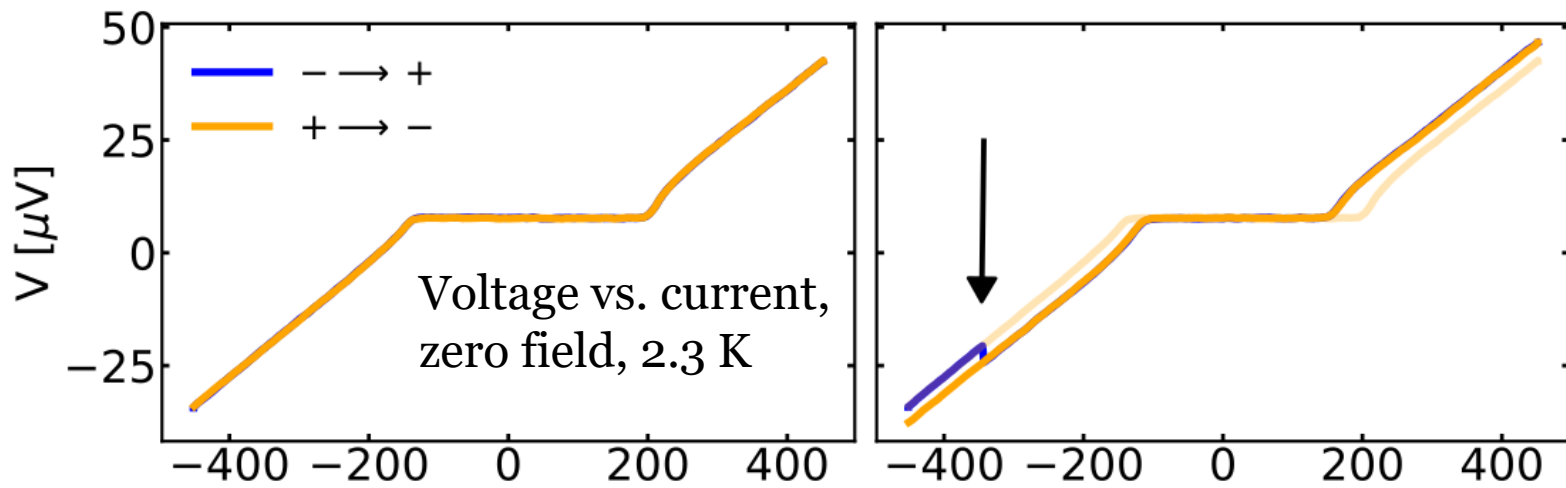
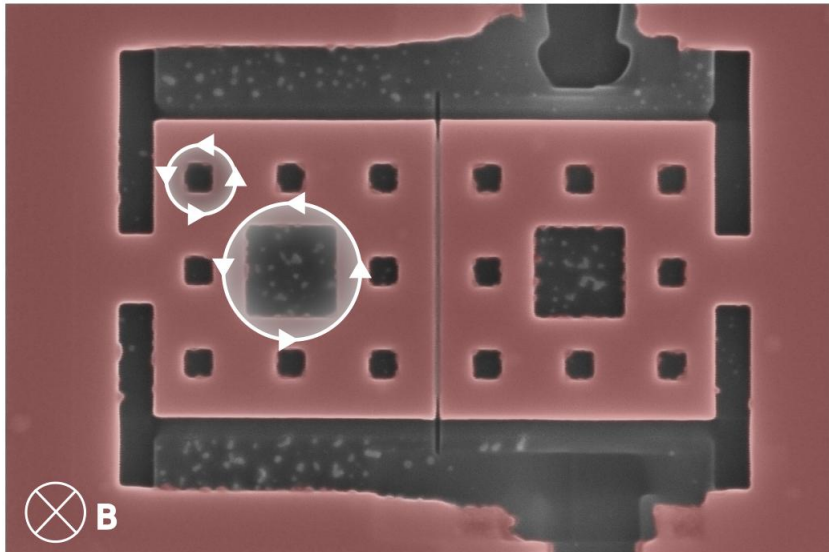
- Vortex trapping



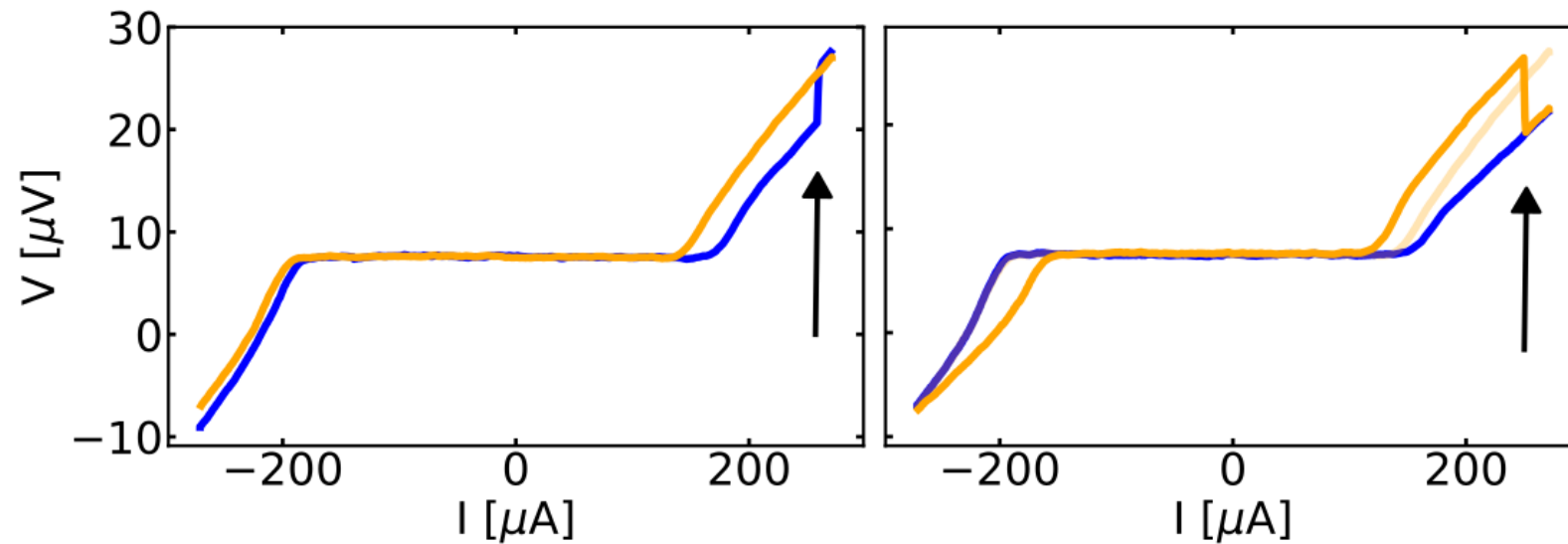
Vortex trapping

Vortex trapping

- Trapped vortex locally changes magnetic field
- Trapped vortex redistributes phase in vicinity > change in shielding currents

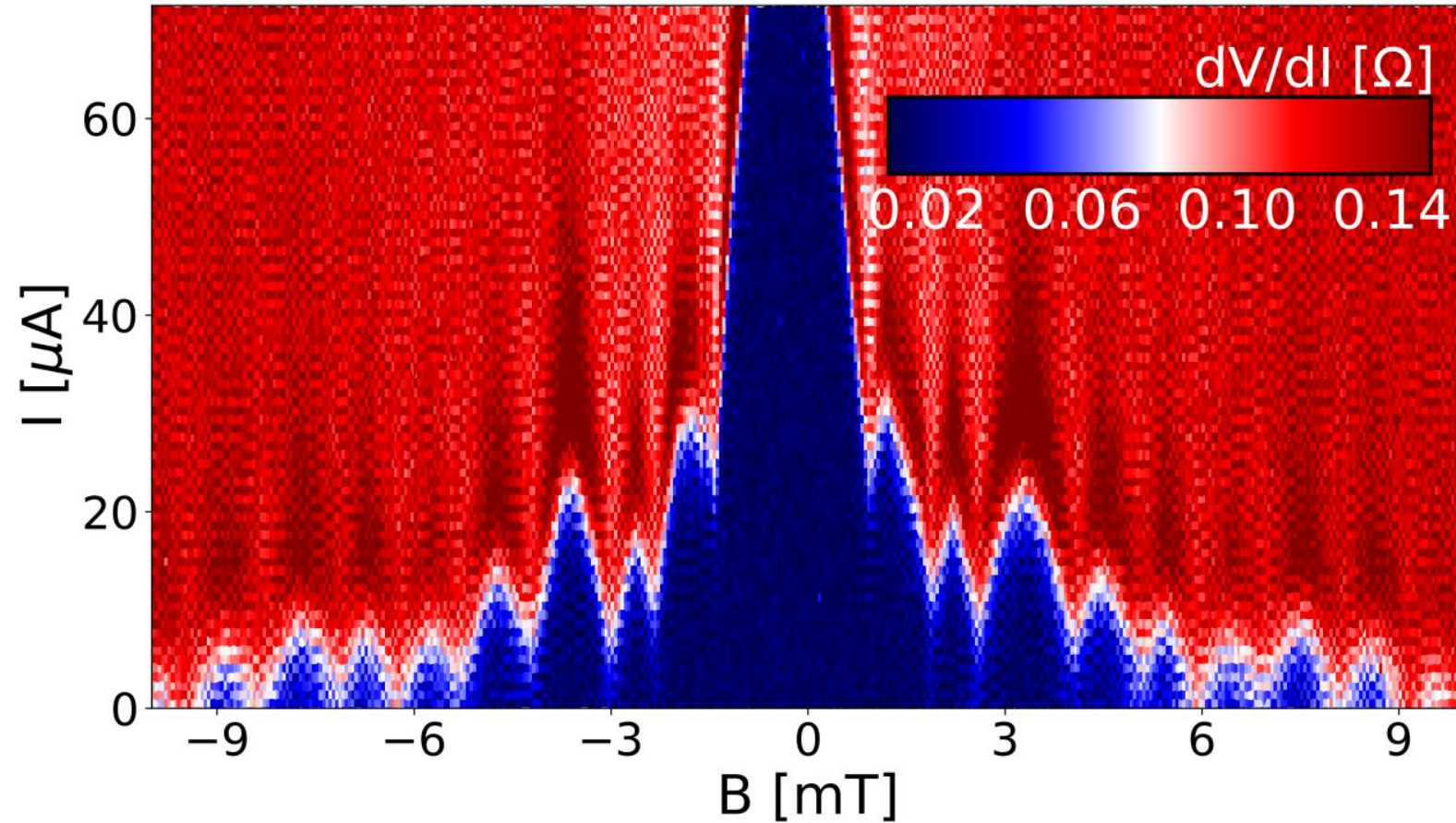


Heat sample to $T > T_c$
And slow cooldown

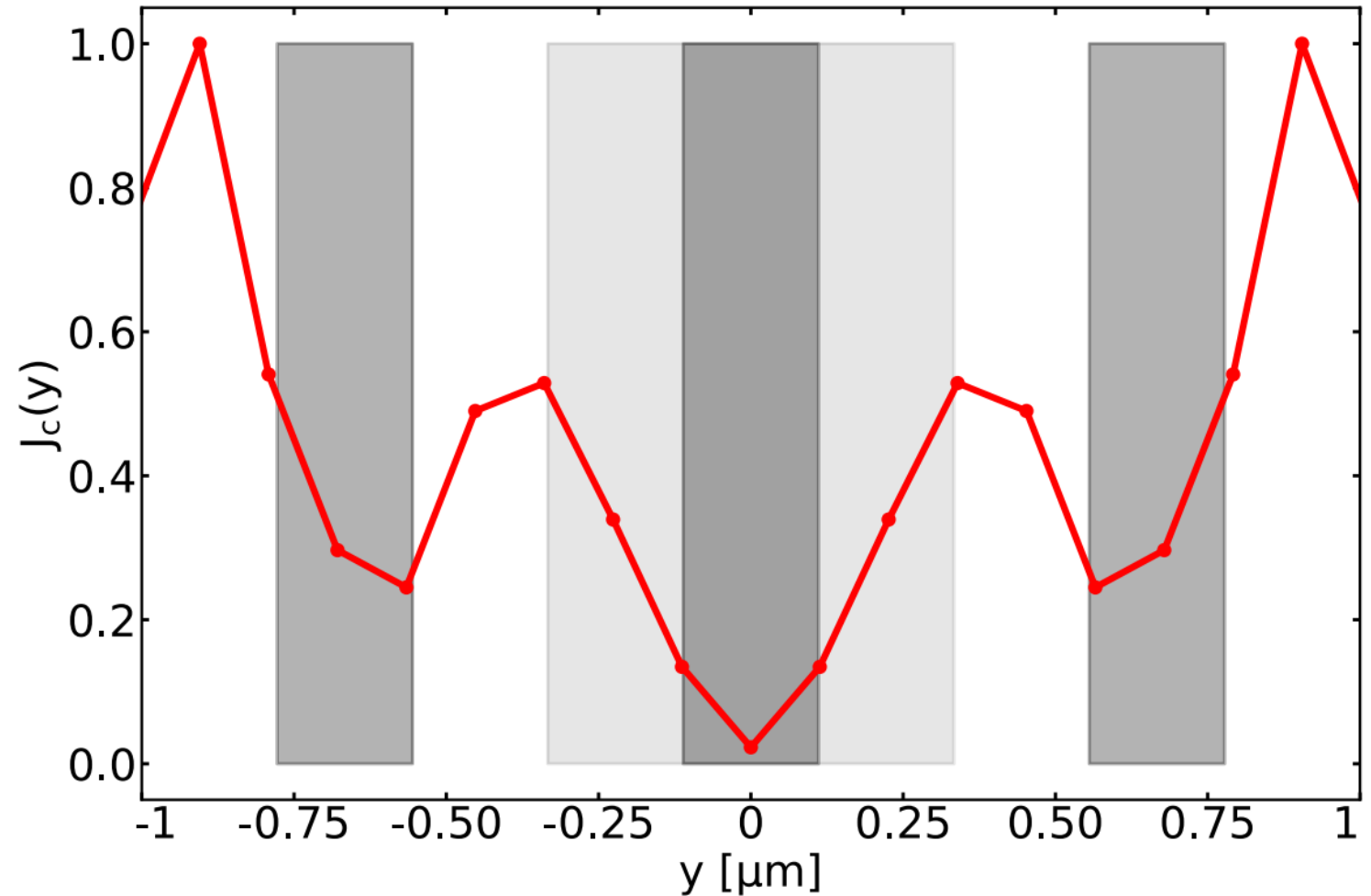
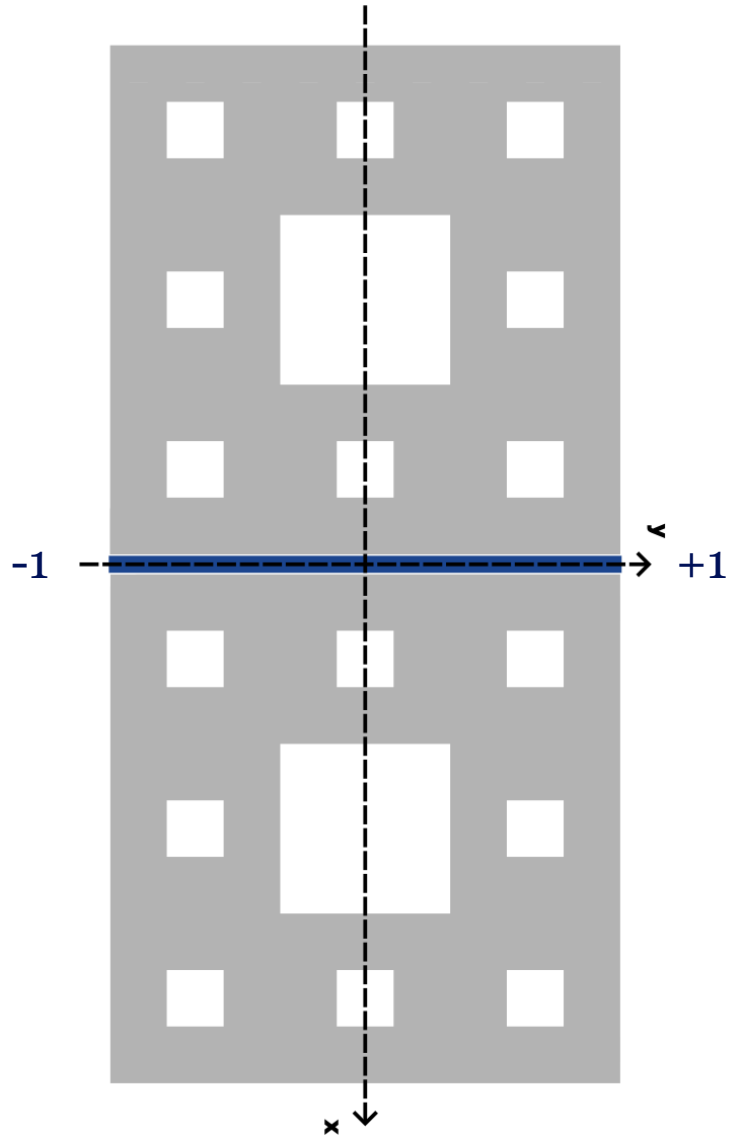


Isolating the contribution of geometry

- Higher temperatures:
 $2.3\text{ K} \rightarrow 3.5\text{ K}$
- Limit probe currents
below $100\text{ }\mu\text{A}$
- Pattern reproduced
multiple times with
intermittent reheating to
 $T > T_c$
- Multiple periodicities



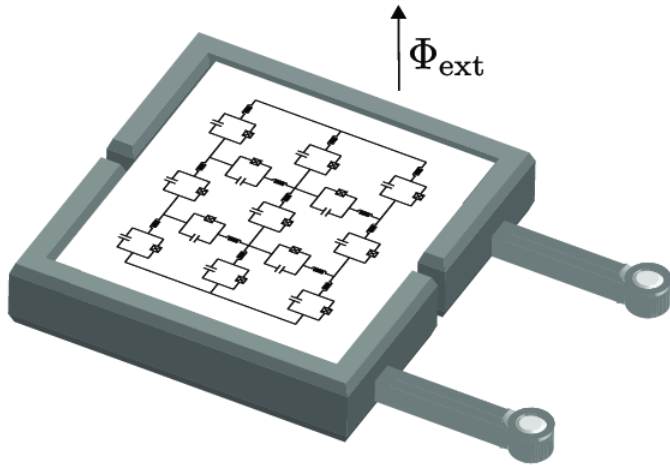
Critical current density distribution



Outlook

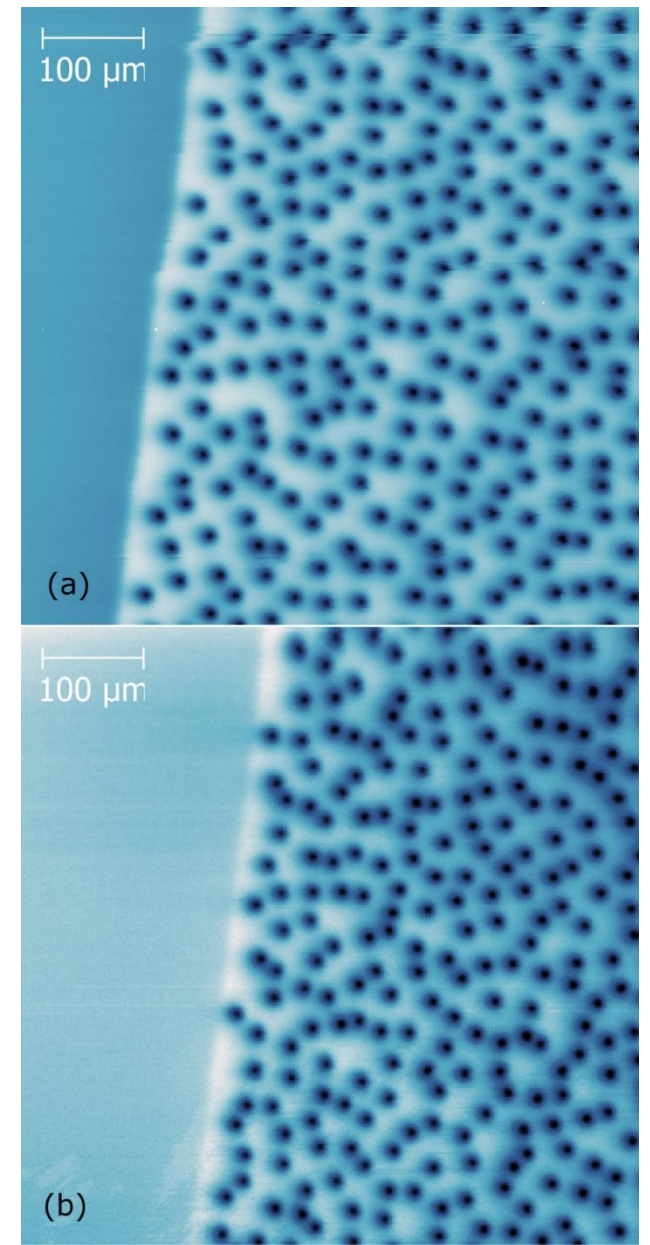
- Josephson junction networks: junction arrays

- ☐ large: easier to structure
- ☐ exciting physics: Giant (fractional) Shapiro steps, commensurability effects, collective rf-response



S. A. Wilkinson, 2018

- Direct imaging of vortex trapping with SQUID on tip?



F. S. Wells, 2015

Thank you



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Final layer composition

Layer	Thickness (nm)	Sputtertime (s)	Presputtertime (s)
Ti	5	100	120
Ag	60	150	120
MoGe	55	589	120
Ti	5	100	120